

## **Tops 5 Power Warm White LED**

## **OSM5XAH5E1E**

VER.1

#### Features

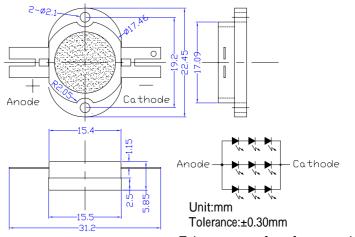
- High-power LED
- Long lifetime operation
- Typical viewing angle: 140deg
- RoHS compliant
- Possible to attach to heat sink directly without using print circuit board.

#### **Applications**

- Indoor & outdoor lighting
- Stage lighting
- Reading lamps
- Display cases, furniture illumination, marker
- Architectural illumination
- **Spotlights**

#### **■Outline Dimension**

(Ta=25)

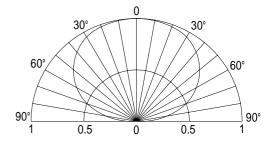


Tolerances are for reference only

# ■Absolute Maximum Rating

Item	Symbol	Value	Unit
DC Forward Current *1	$I_{\mathrm{F}}$	600	mA
Pulse Forward Current*2	$I_{FP}$	1,000	mA
Reverse Voltage	$V_R$	15	V
Power Dissipation*1	$P_{\mathrm{D}}$	6,840	mW
Operating Temperature	Topr	<b>-</b> 30 ∼ +85	
Storage Temperature	Tstg	-40~ +100	
Lead Soldering Temperature	Tsol	260 /5sec	-

# Directivity



#### **Electrical -Optical Characteristics** (Ta=25)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
DC Forward Voltage	$V_{\mathrm{F}}$	I <sub>F</sub> =500mA	8.7	10	11.4	V
DC Reverse Current	$I_R$	$V_R=15V$	-	-	30	μΑ
Luminous Flux	v	I <sub>F</sub> =500mA	300	370	1	lm
Color Temperature	CCT	I <sub>F</sub> =500mA	-	3000	-	K
Chromaticity	X	I <sub>F</sub> =500mA	-	0.45	-	
Coordinates*	у	I <sub>F</sub> =500mA	-	0.41	-	
50% Power Angle	201/2	I <sub>F</sub> =500mA	1	140	1	deg

Note: Don't drive at rated current more than 5s without heat sink for High Power series.

<sup>\*</sup> Tolerance of chromaticity coordinates is  $\pm 10\%$ , \* Tolerance of Luminous Flux is +20%









<sup>\*1,</sup> Power dissipation and forward current are the value when the module temperature is set lower than the rating by using an adequate heat sink.

<sup>\*2,</sup> Pulse width Max.10ms Duty ratio max 1/10

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#### Heat design

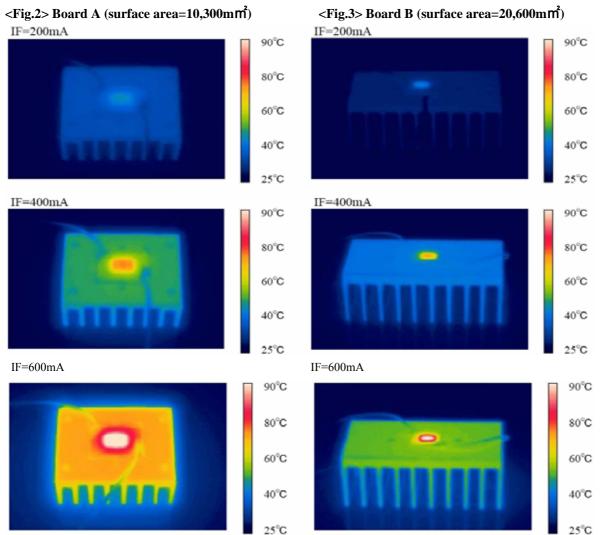
The following pictures show some measurements of mounted 5W Led on the heat sink for each board A and B (See Fig 1) with using thermograph to make an observation about heat distribution. Each boards is tested at various current conditions. As a result, LED needs larger heat sink as much as possible to reduce its own case temperature.

Fig. 1 Configuration pattern examples for board assembly

Board	LED power	Material	Surface area (mm²) Min.
A	5W	Al	10,300
В	10W	Al	20,600
С	25W	Al	51,500
D	50W	Al	103,000
Е	100W	Al	206,000
F	200W	Al	412,000
G	300W	Al	618,000

Above tested LED device is attached with adhesive sheet to the heatsink.

For reference's sake, Tj absolute maximum rating is defined at 115 as a prerequisite on design process of 5W LED.



**LED & Application Technologies** 











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